MARKING

Configurable Dual Supply Octal Transceiver

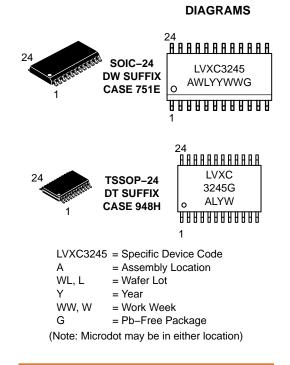
with 3-State Outputs for 3 V Systems

MC74LVXC3245

The 74LVXC3245 is a 24-pin dual-supply, octal configurable voltage interface transceiver especially well suited for PCMCIA and other real time configurable I/O applications. The V_{CCA} pin accepts a 3.0 V supply level; the A port is a dedicated 3.0 V port. The V_{CCB} pin accepts a 3.0 V-to-5.0 V supply level. The B port is configured to track the V_{CCB} supply level. A 5.0 V level on the V_{CCB} pin will configure the I/O pins at a 5.0 V level and a 3.0 V V_{CCB} will configure the I/O pins at a 3.0 V level. The A port interfaces with a 3.0 V host system and the B port to the card slots. This device will allow the V_{CCB} voltage source pin and I/O pins on the B port to float when \overline{OE} is High. This feature is necessary to buffer data to and from a PCMCIA socket that permits PCMCIA cards to be inserted and removed during normal operation. The Transmit/Receive (T/\overline{R}) input determines the direction of data flow. Transmit (active-High) enables data from the A port to B port. Receive (active-Low) enables data from the B port to the A port.

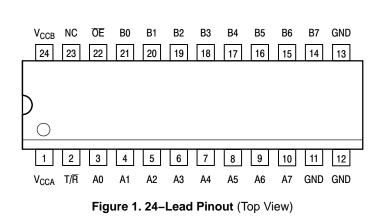
Features

- Bidirectional Interface Between 3.0 V and 3.0 V/5.0 V Buses
- Control Inputs Compatible with TTL Level
- Outputs Source/Sink Up to 24 mA
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- Available in SOIC and TSSOP Packages
- Flexible V_{CCB} Operating Range
- Allows B Port and V_{CCB} to Float Simultaneously When \overline{OE} is High
- Functionally Compatible With the 74 Series 245
- These Devices are Pb-Free and are RoHS Compliant



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet. NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.



PIN NAMES

| Pins | Function |
|-------|--|
| OE | Output Enable Input |
| T/R | Transmit/Receive Input |
| A0–A7 | Side A 3–State Inputs or 3–State Outputs |
| B0–B7 | Side B 3–State Inputs or 3–State Outputs |

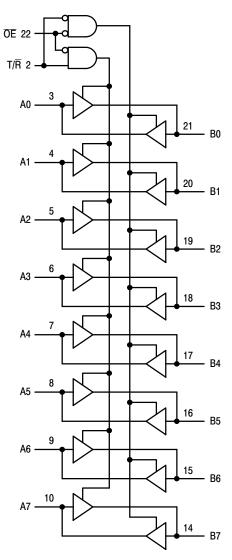


Figure 2. Logic Diagram

| INP | UTS | OPERATING MODE |
|-----|-----|-----------------|
| ŌĒ | T/R | Non-Inverting |
| L | L | B Data to A Bus |
| L | н | A Data to B Bus |
| Н | Х | Z |

H = High Voltage Level; L = Low Voltage Level; Z = High Impedance State; X = High or Low Voltage Level and Transitions are Acceptable; for I_{CC} reasons, Do Not Float Inputs

MAXIMUM RATINGS

| Symbol | Parameter | | Value | Condition | Unit |
|--|--------------------------------|-----------------------------------|-------------------------------|---------------------------|------|
| V _{CCA} , V _{CCB} | DC Supply Voltage | | -0.5 to +7.0 | | V |
| VI | DC Input Voltage | de , t/ r | –0.5 to V _{CCA} +0.5 | | V |
| V _{I/O} | DC Input/Output Voltage | An | –0.5 to V _{CCA} +0.5 | | V |
| | | Bn | –0.5 to V _{CCB} +0.5 | | V |
| Ι _{ΙΚ} | DC Input Diode Current | de , t/ r | ±20 | V _I < GND | mA |
| I _{OK} | DC Output Diode Current | | ±50 | $V_O < GND; V_O > V_{CC}$ | mA |
| Ι _Ο | DC Output Source/Sink Current | | ±50 | | mA |
| I _{CC} , I _{GND} | DC Supply Current | Per Output Pin Maximum Current | ±50 ±200 | | mA |
| T _{STG} | Storage Temperature Range | | -65 to +150 | | °C |
| | DC Latchup Source/Sink Current | | ±300 | | mA |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | | Max | Unit |
|--|---|--------------------------------------|------------|--------------------------------------|------|
| V _{CCA} , V _{CCB} | Supply Voltage (V _{CCA} \leq V _{CCB}) | V _{CCA} V _{CCB} | 2.3 3.0 | 3.6 5.5 | V |
| VI | Input Voltage | ŌĒ, T/R | 0 | V _{CCA} | V |
| V _{I/O} | Input/Output Voltage | An Bn | 0 0 | V _{CCA} V _{CCB} | V |
| T _A | Operating Free–Air Temperature | | -40 | +85 | °C |
| $\Delta t / \Delta V$ | Minimum Input Edge Rate V _{IN} from 30% to 70% of V _{CC} ; V _{CC} at 3.0 V, | 4.5 V, 5.5 V | 0 | 8 | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

| | | | | | | T _A = | 25°C | T _A = −40 to +85°C | |
|------------------|--------------------------------------|-----------------|--|---------------------------------|---------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|------|
| Symbol | Parameter | | Condition | V _{CCA} | V_{CCB} | Тур | Gu | uaranteed Limits | Unit |
| V _{IHA} | Minimum HIGH Level Input Voltage | An OE T/R | V _{OUT} ≤ 0.1 V | 2.3 3.0 3.6 | 3.0 3.6 5.5 | | 2.0 2.0 2.0 | 2.0 2.0 2.0 | V |
| V _{IHB} | | Bn | or ≥ V _{CC} – 0.1 V | 2.3 3.0 3.6 | 3.0 3.6 5.5 | | 2.00 2.00 3.85 | 2.00 2.00 3.85 | V |
| V _{ILA} | Maximum LOW Level Input Voltage | An OE T/R | V _{OUT} ≤ 0.1 V | 2.3 3.0 3.6 | 3.0 3.6 5.5 | | 0.8 0.8 0.8 | 0.8 0.8 0.8 | V |
| V _{ILB} | | Bn | or ≥ V _{CC} – 0.1 V | 2.3 3.0 3.6 | 3.0 3.6 5.5 | | 0.80 0.80 1.65 | 0.80 0.80 1.65 | V |
| V _{OHA} | Minimum HIGH Level Output Voltage | | $I_{OUT} = -100 \ \mu A$ $I_{OH} = -12 \ m A$ $I_{OH} = -24 \ m A$ $I_{OH} = -12 \ m A$ $I_{OH} = -12 \ m A$ $I_{OH} = -24 \ m A$ | 3.0 3.0 3.0 2.3 2.3 | 3.0 3.0 3.0 3.0 4.5 | 2.99 2.85 2.65 2.50 2.30 | 2.90 2.56 2.35 2.30 2.10 | 2.90 2.46 2.25 2.20 2.00 | V |
| V _{OHB} | | | $I_{OUT} = -100 \ \mu A$ $I_{OH} = -12 \ m A$ $I_{OH} = -24 \ m A$ $I_{OH} = -24 \ m A$ | 3.0 3.0 3.0 3.0 | 3.0 3.0 3.0 4.5 | 2.99 2.85 2.65 4.25 | 2.90 2.56 2.35 3.86 | 2.90 2.46 2.25 3.76 | V |

DC ELECTRICAL CHARACTERISTICS

| | | | | | | T _A = | 25°C | T _A = −40 to +85°C | |
|-------------------|--|-----------------|--|--------------------------|--------------------------|-------------------------------|------------------------------|-------------------------------|------|
| Symbol | Parameter | | Condition | V _{CCA} | V _{CCB} | Тур | G | uaranteed Limits | Unit |
| V _{OLA} | Maximum LOW Level Output Voltage | | I _{OUT} = 100 μA I _{OL} = 24 mA I _{OL} = 12 mA I _{OL} = 24 mA | 3.0 3.0 2.7 2.7 | 3.0 3.0 3.0 4.5 | 0.002 0.21 0.11 0.22 | 0.10 0.36 0.36 0.42 | 0.10 0.44 0.44 0.50 | V |
| V _{OLB} | | | I _{OUT} = 100 μA I _{OL} = 24 mA I _{OL} = 24 mA | 3.0 3.0 3.0 | 3.0 3.0 4.5 | 0.002 0.21 0.18 | 0.10 0.36 0.36 | 0.10 0.44 0.44 | V |
| I _{IN} | Max Input Leakage Current | OE, T/R | $V_{I} = V_{CCA}, GND$ | 3.6 3.6 | 3.6 5.5 | | ±0.1 ±0.1 | ±1.0 ±1.0 | μΑ |
| I _{OZA} | Max 3–State Output Leakage | An | | 3.6 3.6 | 3.6 5.5 | | ±0.5 ±0.5 | ±5.0 ±5.0 | μΑ |
| I _{OZB} | Max 3–State Output Leakage | Bn | $V_{I} = V_{IH}, V_{IL}$ $\overline{OE} = V_{CCA}$ $V_{O} = V_{CCB}, GND$ | 3.6 3.6 | 3.6 5.5 | | ±0.5 ±0.5 | ±5.0 ±5.0 | μΑ |
| ΔI_{CC} | Maximum I _{CC} /Input | Bn | $V_I = V_{CCB} - 2.1 V$ | 3.6 | 5.5 | 1.0 | 1.35 | 1.5 | mA |
| | | All In- puts | $V_{I} = V_{CC} - 0.6 V$ | 3.6 | 3.6 | | 0.35 | 0.5 | mA |
| I _{CCA1} | Quiescent V _{CCA} Sup- ply Current as B Port Floats | | | 3.6 | Open | | 5 | 50 | μΑ |
| I _{CCA2} | Quiescent V _{CCA} Sup- ply Current | | $\begin{array}{l} \text{An} = V_{CCA} \text{ or GND} \\ \text{Bn} = V_{CCB} \text{ or} \\ \text{GND, } \overline{\text{OE}} = \text{GND}, \\ \overline{\text{T/R}} = \text{GND} \end{array}$ | 3.6 3.6 | 3.6 5.5 | | 5 5 | 50 50 | μΑ |
| I _{CCB} | Quiescent V _{CCB} Supply Current | | | 3.6 3.6 | 3.6 5.5 | | 5 8 | 50 80 | μΑ |
| V _{OLPA} | Quiet Output Max Dy- namic V _{OL} | | Notes 1, 2 | 3.3 3.3 | 3.3 5.0 | | 0.8 0.8 | | V |
| V _{OLPB} | | | Notes 1, 2 | 3.3 3.3 | 3.3 5.0 | | 0.8 1.5 | | V |
| V _{OLVA} | Quiet Output Min Dy- namic V _{OL} | | Notes 1, 2 | 3.3 3.3 | 3.3 5.0 | | -0.8 -0.8 | | V |
| V _{OLVB} | | | Notes 1, 2 | 3.3 3.3 | 3.3 5.0 | | -0.8 -1.2 | | V |
| V _{IHDA} | Min HIGH Level Dy- namic Input Voltage | _ | Notes 1, 3 | 3.3 3.3 | 3.3 5.0 | | 2.0 2.0 | | V |
| V _{IHDB} | | | Notes 1, 3 | 3.3 3.3 | 3.3 5.0 | | 2.0 3.5 | | V |
| V _{ILDA} | Max LOW Level Dy- namic Input Voltage | | Notes 1, 3 | 3.3 3.3 | 3.3 5.0 | | 0.8 0.8 | | V |
| V _{ILDB} | | | Notes 1, 3 | 3.3 3.3 | 3.3 5.0 | | 0.8 1.5 | | V |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
1. Worst case package.
2. Max number of outputs defined as (n). Data inputs are driven 0 V to V_{CC} level; one output at GND.
3. Max number of data inputs (n) switching. (n–1) inputs switching 0 V to V_{CC} level. Input under test switching: V_{CC} level to threshold (V_{IHD}), 0 V to threshold (V_{ILD}), f = 1 MHz.

AC ELECTRICAL CHARACTERISTICS

| | | $T_A = -40$ to +85°C; $C_L = 50$ pF | | | | | | |
|--|---|-------------------------------------|--|-------------|--|-----------------|-------------|------|
| | | V _C V _C | _{CA} = 2.7–3.0 _{CB} = 4.5–5.5 | 6 V 5 V | V _{CCA} = 2.7–3.6 V V _{CCB} = 3.0–3.6 V | | | |
| Symbol | Parameter | Min | Typ (Note 4) | Max | Min | Typ (Note 5) | Max | Unit |
| t _{PHL} t _{PLH} | Propagation Delay A to B | 1.0 1.0 | 4.8 3.9 | 8.5 7.0 | 1.0 1.0 | 5.5 5.2 | 9.0 8.5 | ns |
| t _{PHL} t _{PLH} | Propagation Delay B to A | 1.0 1.0 | 3.8 4.3 | 7.0 8.0 | 1.0 1.0 | 4.4 5.1 | 7.5 8.0 | ns |
| t _{PZL} t _{PZH} | Output Enable Time OE to B | 1.0 1.0 | 4.7 4.8 | 8.5 9.0 | 1.0 1.0 | 6.0 6.1 | 9.5 10.0 | ns |
| t _{PZL} t _{PZH} | Output Enable Time OE to A | 1.0 1.0 | 5.9 5.4 | 10.0 9.5 | 1.0 1.0 | 6.4 5.8 | 10.5 9.5 | ns |
| t _{PHZ} t _{PLZ} | Output Disable Time OE to B | 1.0 1.0 | 4.0 3.8 | 8.5 8.0 | 1.0 1.0 | 6.3 4.5 | 10.0 8.5 | ns |
| t _{PHZ} t _{PLZ} | Output Disable Time OE to A | 1.0 1.0 | 4.6 3.1 | 10.0 7.0 | 1.0 1.0 | 5.2 3.4 | 10.0 7.0 | ns |
| t _{OSHL} t _{OSLH} | Output to Output Skew, Data to Output (Note 6) | | 1.0 | 1.5 | | 1.0 | 1.5 | ns |

Typical values at V_{CCA} = 3.3 V, V_{CCB} = 5.0 V at 25°C. 4.

5. Typical values at $V_{CCA} = 3.3 \text{ V}$, $V_{CCB} = 3.3 \text{ V}$ at 25°C. 6. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (toSHL) or LOW-to-HIGH (toSLH); parameter guaranteed by design.

CAPACITIVE CHARACTERISTICS

| Symbol | Parameter | | Condition | Typical | Unit |
|------------------|---|------------|--|----------|------|
| C _{IN} | Input Capacitance | | $V_{CCA} = 3.3 \text{ V}; V_{CCB} = 5.0 \text{ V}$ | 4.5 | pF |
| C _{I/O} | Input/Output Capacitance | | $V_{CCA} = 3.3 \text{ V}; V_{CCB} = 5.0 \text{ V}$ | 10 | pF |
| C _{PD} | Power Dissipation Capacitance (Measured at 10 MHz) | A→B B→A | V _{CCB} = 5.0 V V _{CCA} = 3.3 V | 50 40 | pF |

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|------------------|------------------------|-----------------------|
| MC74LVXC3245DTRG | TSSOP-24* (Pb-Free) | 2500 Tape & Reel |

DISCONTINUED (Note 7)

| MC74LVXC3245DWRG | SOIC-24 (Pb-Free) | 1000 Tape & Reel |
|-------------------|------------------------|------------------|
| MC74LVXC3245DTG | TSSOP-24* (Pb-Free) | 62 Units / Rail |
| MC74LVXC3245DTR2G | TSSOP-24* (Pb-Free) | 2500 Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

7. DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

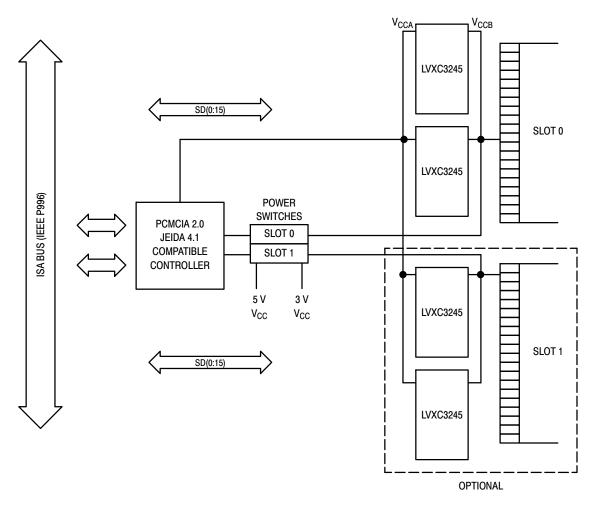


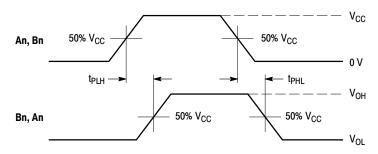
Figure 3. Block Diagram

Configurable I/O Application for PCMCIA Cards

The 74LVXC3245 is a dual–supply device well suited for PCMCIA configurable I/O applications. The LVXC3245 consumes less than 1mW of quiescent power in all modes of operation, making it ideal for low power notebook designs. The LVXC3245 meets all PCMCIA I/O voltage requirements at 5.0 V and 3.3 V operation. By tying the V_{CCB} pin to the card voltage supply, the PCMCIA card will always have

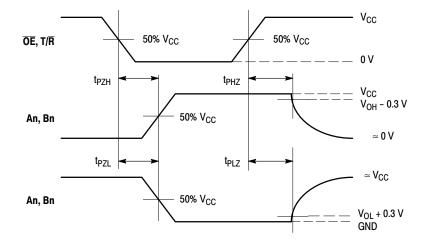
rail-to-rail output swings, maximizing the reliability of the interface.

The V_{CCA} pin must always be tied to a 3.3 V power supply. This voltage connection provides internal references needed to account for variations in V_{CCB}. When connected as in the figure above, the LVXC3245 meets all the voltage and current requirements of the ISA bus standard (IEEE P996).



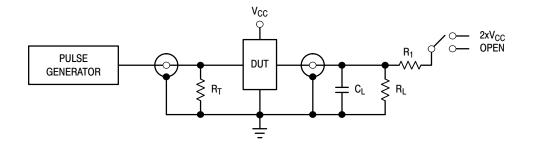
WAVEFORM 1 - PROPAGATION DELAYS

 t_{R} = t_{F} = 2.5 ns, 10% to 90%; f = 1 MHz; t_{W} = 500 ns



WAVEFORM 2 - OUTPUT ENABLE AND DISABLE TIMES t_{R} = t_{F} = 2.5 ns, 10% to 90%; f = 1 MHz; t_{W} = 500 ns





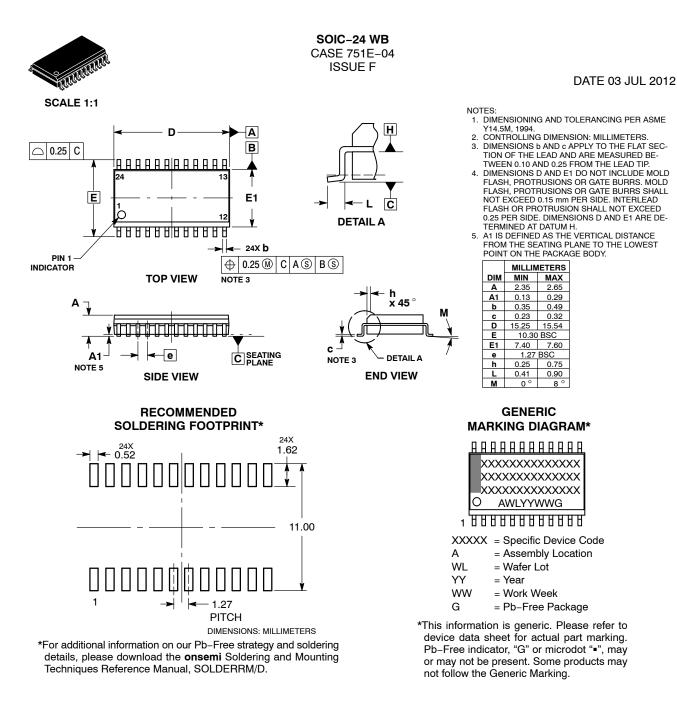
| TEST | SWITCH |
|-------------------------------------|-------------------|
| tplh, tphl, tpzh, tphz | Open |
| t _{PZL} , t _{PLZ} | 2xV _{CC} |

 C_L = 50 pF or equivalent (Includes jig and probe capacitance)

 $R_L = R_1 = 500 \ \Omega \text{ or equivalent} \\ R_T = Z_{OUT} \text{ of pulse generator (typically 50 } \Omega)$

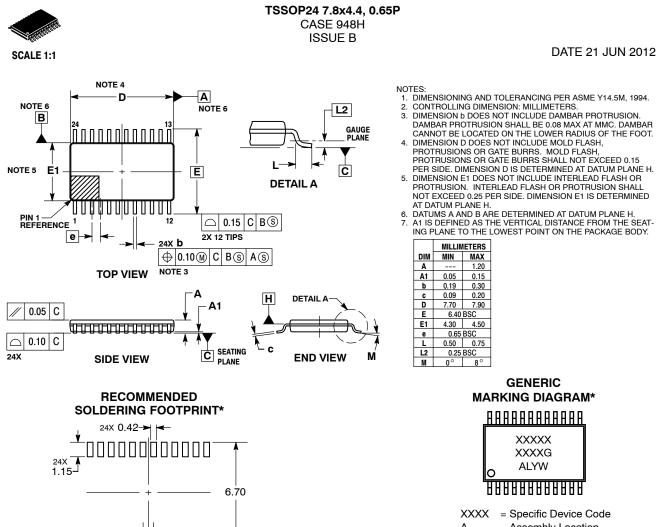


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XXXX = Specific Device Code A = Assembly Location L = Wafer Lot Y = Year W = Work Week G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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Techniques Reference Manual, SOLDERRM/D.

DIMENSIONS: MILLIMETERS

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